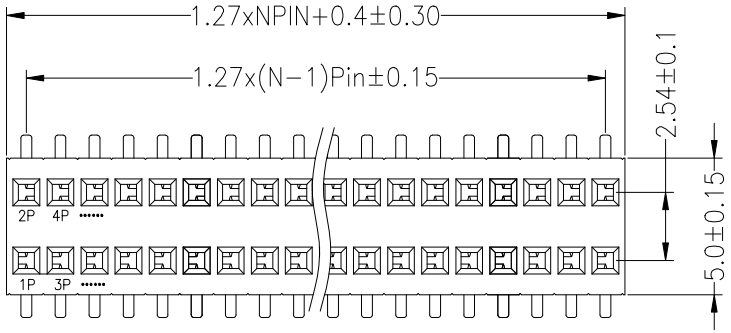
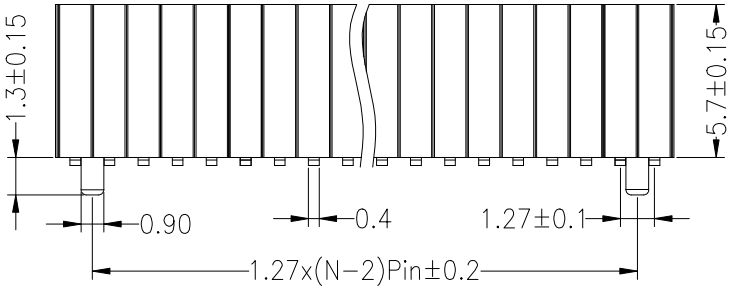
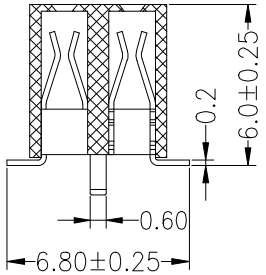
HSF RoHS

SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

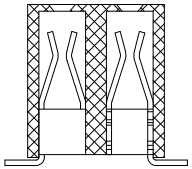
Contact Material:Phosphor Bronze
Contact Plating:Au Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)







W= With Post

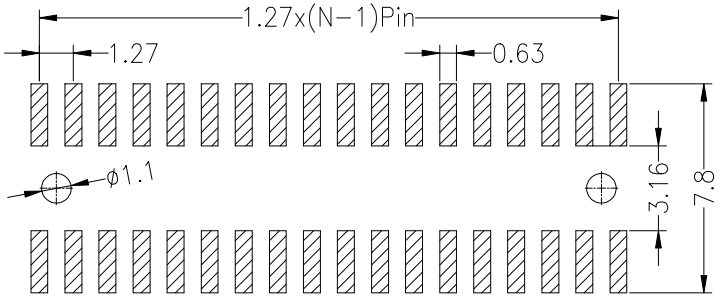


N= W/O Post

Ordering Information

2557 02 XX X X XX M U X 0X

- No.of Pins Per Row 3~50
- Insulator Material Option
  - C=BK−PA6T
  - D=BK−PA46
  - E=BK−PA9T
  - F=BK−LCP
- Contact Plating
  - G1:Gold Flash
  - G3:2U" Gold
  - G4:3U" Gold
  - G5:5U" Gold
  - S0:Gold Flash/Tin
  - SN:Tin
- Packing
  - 0=PE Bag
  - A=Tray
  - T=Tube
  - P=Tube+Cap
  - R=Reel+Cap
  - M=Reel+Mylar



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2020.02.25	NEW DRAWING	

OPERATION		DRAW	Liu Miao	20.02.25
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	255702XXXXXXMUX0X
TITLE:	1.27*2.54PF 2xNPin H5.7mm SMT W6.8